

# Process Interface Motherboard for 16 PI/Ex... Modules PI/Ex-MB/16/D-SUB

# 1. Short Description

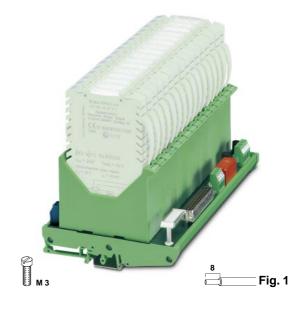
For signal level matching in large or medium-sized process control systems, in particular for applications in which system cabling is used, multiple channel motherboards are available to accept the pluggable PI/Ex-i-Interface modules.

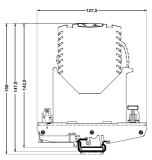
16 electronic bases are grouped together on a motherboard on a sturdy, rail mountable PC board base, to accept the pluggable electronic modules. The power supply is fed in centrally. On the system side, a multiple plug allows all modules to be connected directly to the input/output module.

- The extremely compact design of these modules allows a high packing density without loss of individual measurement circuit integrity.
- Typical for PI, the self-coding module electronics need merely be snapped into the electronic base where they lock in to be vibration-proof.
- There is no need to remove conductors to replace modules. This simplifies installation and maintenance reducing time, costs and frequency of faults.
- It is simple to retain reserves, as only as many Process Interface modules as are required at the time of initial operation are installed. Costs for otherwise unused channels are therefore not incurred.
- Just as is the case for the module electronics, each base can be labelled easily and conveniently with the marking material from the Phoenix marking range (see Modular Terminal Block catalog).
- The development of individual modules to perfectly suit your applications is unrestricted, e.g with different multiple connectors such as ELCO, D-SUB or FLK to connect to the Phoenix PLC system cabling.

#### **Further Features:**

- Redundant supply decoupled from diode
- Fuse monitoring with LED and relay contact (PDT)
- Terminal points for error messages if the fuse burns
- Protection against polarity reversal





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Fig. 2



Fig. 3

Fig. 4

## 2. Technical Data

## PI/Ex-MB/16/D-SUB

for 16 PI/Ex... modules

(IEC) [mm <sup>2</sup> ]	rigid solid	flexible stranded	AWG	I [A]	U [V DC]	
Connection data	0.2-4	0.2-2.5	24-12	1	35	

2.1. Description	Туре	Order No.	Pcs. Pkt.
Motherboard, takeup for 16 PI/Ex Process Interface modules, for mounting on □ or □ r	PI/Ex-MB/16/D-SUB	28 35 38 3	1

## 2.2. Accessories

System-specific adapter	r printed	circuit	boards
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## Zack marker sheets and marking

#### on request

#### see catalog Modular Terminal Blocks

#### 2.3. General Data

Connection to control system level

Supply Nominal voltge Polarity reversal protection Operating voltage monitoring

Safety monitoring

Load carrying capacity of alarm contact switching power switching current switching voltage

Connection to field level (Ex-area) Dimensions (W x H x D, equipped) Approval

37-pos. D-SUB pin strip (DIN 41652/IEC 807-2) max perm. current = 1A (125 V AC/DC) redundant, decoupled from diode 20 -35 V DC

failure of one of the two power supplies is signalized by the green LED extinguishing and the relay contact opening/closing.

a burning fuse is signalized by a red LED and the relay contact  $% \left( 1\right) =\left( 1\right) \left( 1\right) +\left( 1\right) \left( 1\right) \left( 1\right)$ opening/closing.

max. 1250 VA max. 5 A max. 250 V

16 printed circuit screw terminal blocks (2-pos.)

223 mm x 154 mm x 127.5 mm acc. to ATEX 100a (EN 50014/EN50020) - applied for

# 2.4. Standards/regulations

Air and creepage distances

EN 50020 IEC 60664 (1980)/IEC 60664 (1981) DIN VDE 0110

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